

# DRAWING FOR CUSTOMER

## NOTES:

### 1. MATERIAL:

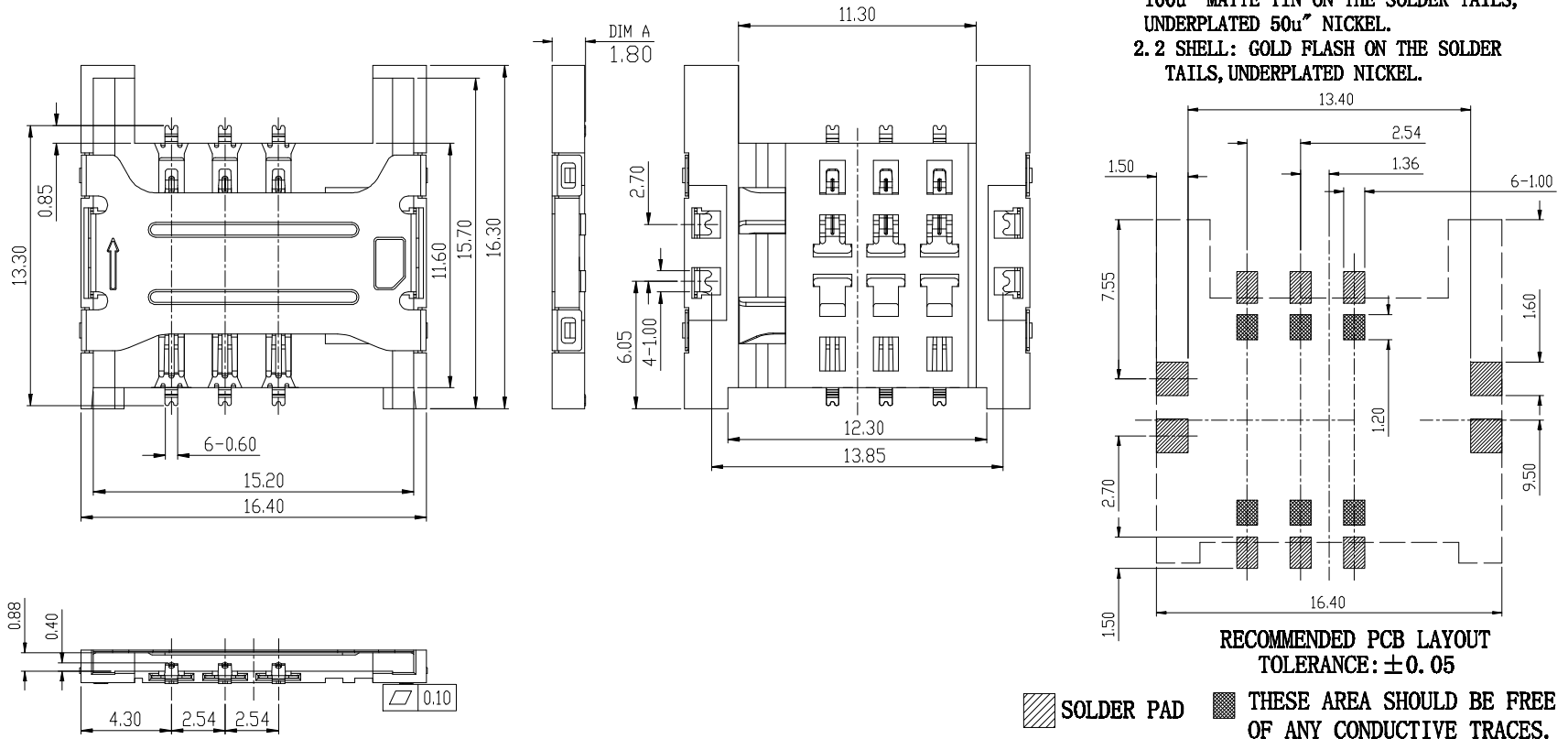
- 1.1 HOUSING: THERMOPLASTIC, UL94V-0, BLACK
- 1.2 TERMINAL: COPPER ALLOY
- 1.3 SHELL: SUS

### 2. FINISH:

#### 2.1 TERMINAL:

G/F Au ON THE CONTACT AREA,  
100u" MATTE TIN ON THE SOLDER TAILS,  
UNDERPLATED 50u" NICKEL.

#### 2.2 SHELL: GOLD FLASH ON THE SOLDER TAILS, UNDERPLATED NICKEL.



RECOMMENDED PCB LAYOUT  
TOLERANCE: ±0.05

▨ SOLDER PAD    ■ THESE AREA SHOULD BE FREE OF ANY CONDUCTIVE TRACES.

TABLE B:

3	SHELL	1PCS	Stainless steel, Ni plat over all, Au G-Flash plat on solder
2	CONTACT	6PCS	Phosphor bronze, Ni plat over all, Au G-Flash plat on solder and contact area
1	HOUSING	1PCS	Thermo plastics BLACK
ITEM	NAME	Q'TY	NOTES

Rev.	ECN Number	Description	Drawn	Date
A		RELEASED	Frank	2014.09.04
B		变更LOGO, 变更为SIM卡标志	张清	2018.08.18



GENERAL TOLERANCE		SCALE	1:1	DRAWN BY	DATE	DWG NO.	TITLE	REV
XX. ±0.30	XXX. ° ±4°	UNIT	mm	CHECKED BY	DATE	PART NO.	1.8H SIM卡 (有档)	B
X. ±0.25	XX. ° ±3°							SHEET
.X ±0.20	X. ° ±2°	SIZE	A4	APPROVED BY	DATE	XDSM-06185-0412		1/1
.XX ±0.15	.X ° ±1°							